AS	PC SSOCIATION CONNECTING ECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannocl Iternational and Pan-Americ	kburn, Illinois	. All rights reserve	tion with lower	level pa	rts, the d	leclaratior	n encompa		er level mate	erials for	which the	item is an assembly a manufacturer has aclaration.	
1752-2         1.1         IPC Web Site for Information           http://www.ipc.org/IPC-1         1					Form Distril	Type * oute			ation Class * 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat							
Supplier Information																
Company Name *			Company Unique ID		Unique ID Au	Response Date *			Re	Response Document ID						
SEMTECH CORPORATION			SEMTECH CORPOR	RATION		2012-06-08										
Contact Name *			Title - Contact		Phone - Con	Email - Contact *				Duralizata	Original	A 4 la .				
ROYA READER			Quality Assurance C	ustomer S	805-389-274	rreader@semtech.com				Duplicate	Contact -	> Autho	orized Rep	presentative		
Authorized Representative		ive *	Title - Representative		Phone - Representative *		Email - Representative *			* Su	Supplier Comments or URL for Additional Information					
ROYA READER			Quality Assurance C	ustomer S	805-389-274	rreader@semtech.com										
Requester Item Number		r	Mfr Item Number		Mfr Item Name	Effective	e Date Version Manuf			uring Site	Weight *	UC	M	Unit Type		
	SDC15.TCT		SDC15.TCT	TVS Diode Array for ESD Prote			С	China			8.355			)	Each	
	Alternate Recommendation						Alternate Item C			ments						
Ма	Manufacturing Process Information															
Terminal Plating / Grid Array Material			al	Terminal B	ase Alloy	J-STD-020 MSL Ra	ting Peak Process I		ess Body	Temperatu	ature Max Time at Peak Tem		perature Number of Reflow Cyc		f Reflow Cycles	
Matte Tin (Sn)				Alloy 42		1			2	2 <b>60</b> C	<b>30</b> se		conds	conds 3		
	Comments SDC15.TCT is REACH-compliant product, per EU Regulation EC1907/2006 to include recent addition of SVHC candidate list of substances in February 2012.															

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
<b>RoHS Materia</b>	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		1	_evel	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		РРМ
	Name		Material	Weight	Measure				oubstance oategory			oubstance		Exempt	Weight	Measure	-	+	
+  -	Die	+M -M	Doped Silicon	0.1309	mg	+C	-C SI	upplier		+S	-S	Si	7440-21-3		0.1309	mg			15,665
+  -	Lead Frame	+M -M	Alloy 42	2.44319	mg	+C	-C SI	upplier		+S	-S	Fe	7439-89-6		1.4085	mg			168,57
						+C	-С в		Nickel (external applic	+S	-S	Nickel	7440-02-0		1.0017	mg			119,89
						+C	-C SI	upplier		+S	-s	Mn	7439-96-5		0.0147	mg			1,754
										+S	-S	Cr(not Cr6+)	7440-47-3		0.0024	mg			292
										+S	-S	Co	7440-48-4		0.0122	mg			1,462
										+S	-S	Si	7440-21-3		0.0037	mg			439
		+M -M	Silver plating	0.1034	mg	+C	-C Si	upplier		+S	-s	Ag	7440-22-4		0.1034	mg			12,380
+  -	Bonding wire	+M -M	Gold Wire	0.0432	mg	+C	-C Si	upplier		+S	-s	Au	7440-57-5		0.0432	mg		-	5,176
+  -	Molding compound	+M -M	CEL-1702HF-9	5.5143	mg	+C	-C Si	upplier		+S	-s	SiO2	60676-86-0		4.8139	mg		-	576,15
										+S	-s	Epoxy Resin	29690-82-2		0.2757	mg			32,999
										+S	-s	Phenol Resin	26834-02-6		0.2757	mg			32,999
										+S	-S	Aromatic poly-phospha	Proprietary		0.1379	mg			16,499
										+S	-s	Carbon	1333-86-4		0.011	mg			1,320
+  -	Die attached epoxy	+M -M	84-1LMISR4	0.05267 <sup>-</sup>	Img	+C	-C SI	upplier		+S	-s	Ag	7440-22-4		0.0395	mg			4,728
										+S	-S	epoxy resin	Proprietary		0.0105	mg			1,261
										+S	-S	curing agent & hardene	Proprietary		0.0026	mg			315
+  -	Tin Solder	+M -M	Pure Tin	0.0676	mg	+C	-C SI	upplier		+S	-s	Sn	7440-31-5		0.0676	mg			8,086